

General specifications

Insulator material	LCP, UL94V-0, color: black
Contact material	Copper alloy
Current rating	0.5 A
Voltage rating	35 VAC
Contact resistance	50 mΩ max.
Insulator resistance	500 MΩ min.
Dielectrical withstanding	200 VAC for 1 min
Operating temperature	-40 °C to +80 °C
Soldering	JEDEC lead free reflow soldering process
Durability	50 cycles

Mating parts series

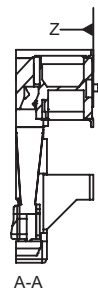
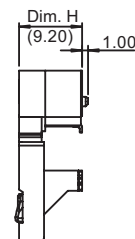
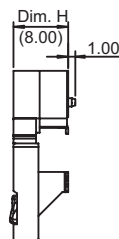
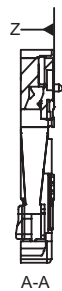
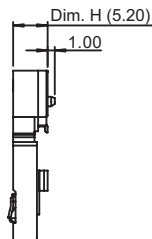
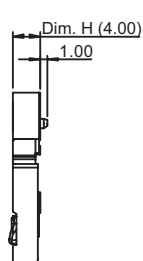
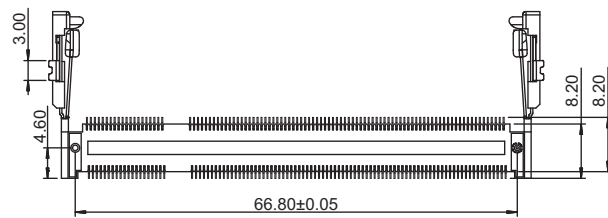
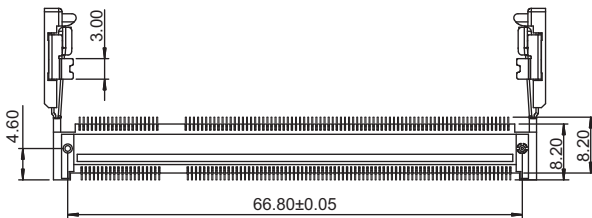
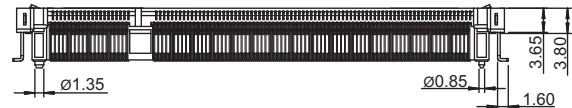
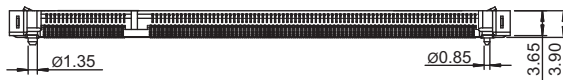
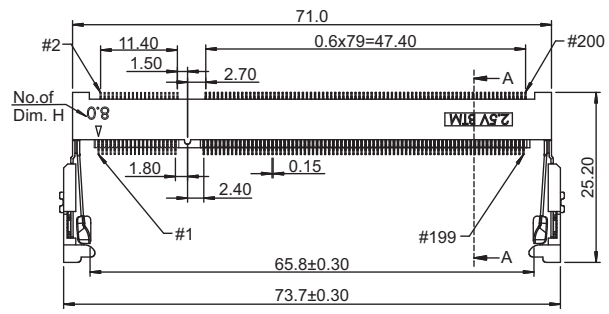
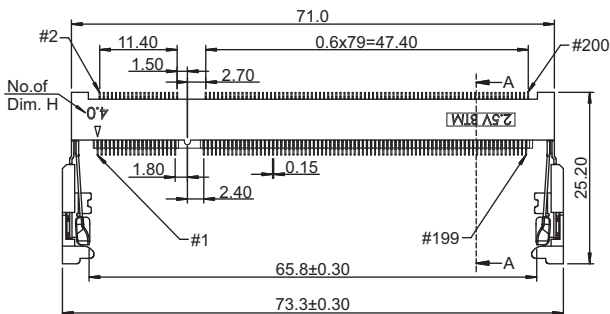


Mechanical dimensions

Unit: mm

H: 4.0 to 5.2 mm

H: 8.0 to 9.2 mm



Tolerances		
Linear	X.	± 0.30
	X	± 0.20
	XX	± 0.10
	XXX	± 0.05

Note:
Solder tail to be within 0.05 upward and 0.2 downward from Z-datum place.
Coplanarity of solder tails to be within 0.10. Measurement point is solder tails tip.

continued on page 2

Part numbering guide

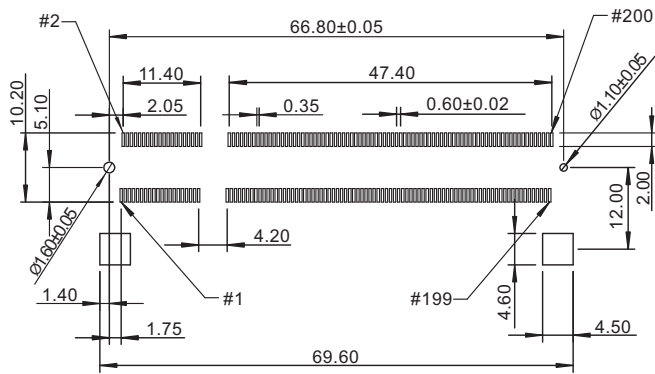
5215 H	B	40
Series	Contact plating	Height Dim. H
H = SMT horizontal	B = Flashgold	40 = 4.0 mm
		52 = 5.2 mm
		80 = 8.0 mm
		92 = 9.2 mm

* standard

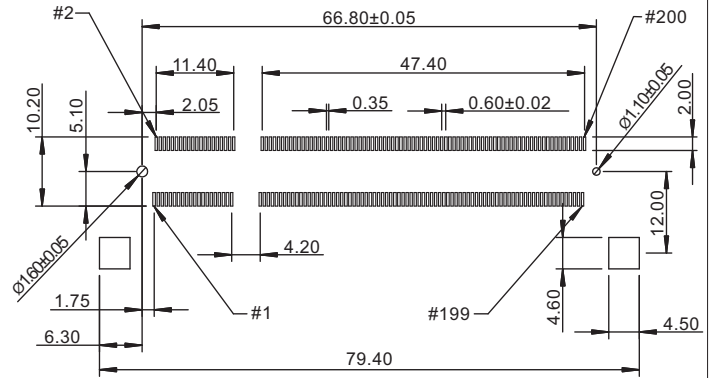


Mechanical dimensions

Unit: mm

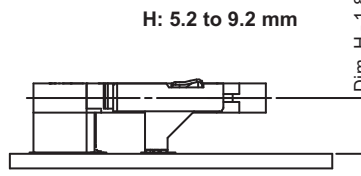
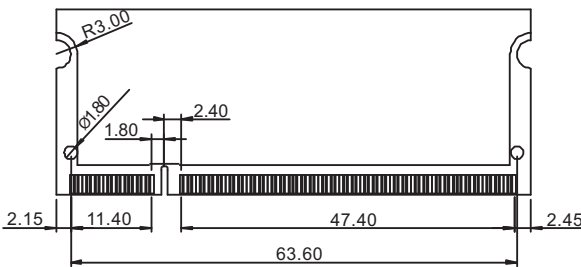
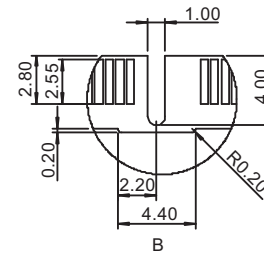
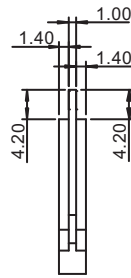
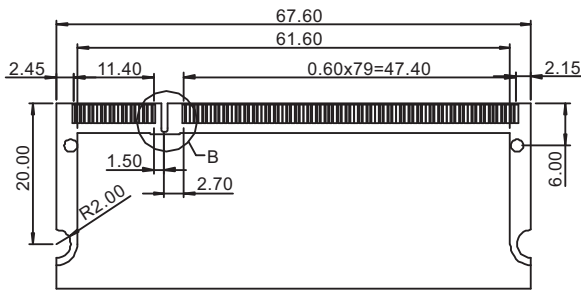


Recommended P.C.B. layout
H: 4.0 to 5.2 mm

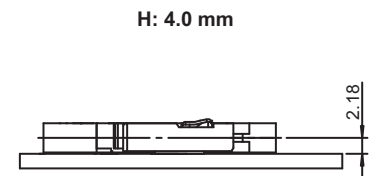


Recommended P.C.B. layout
H: 8.0 to 9.2 mm

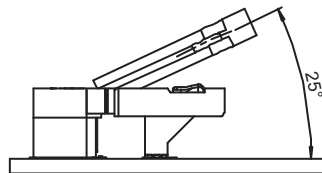
Example of DDR 200 pin extension board



H: 5.2 to 9.2 mm



H: 4.0 mm



Tolerances		
Linear	X.	± 0.30
	.X	± 0.20
	.XX	± 0.10
	.XXX	± 0.05

continued on page 3

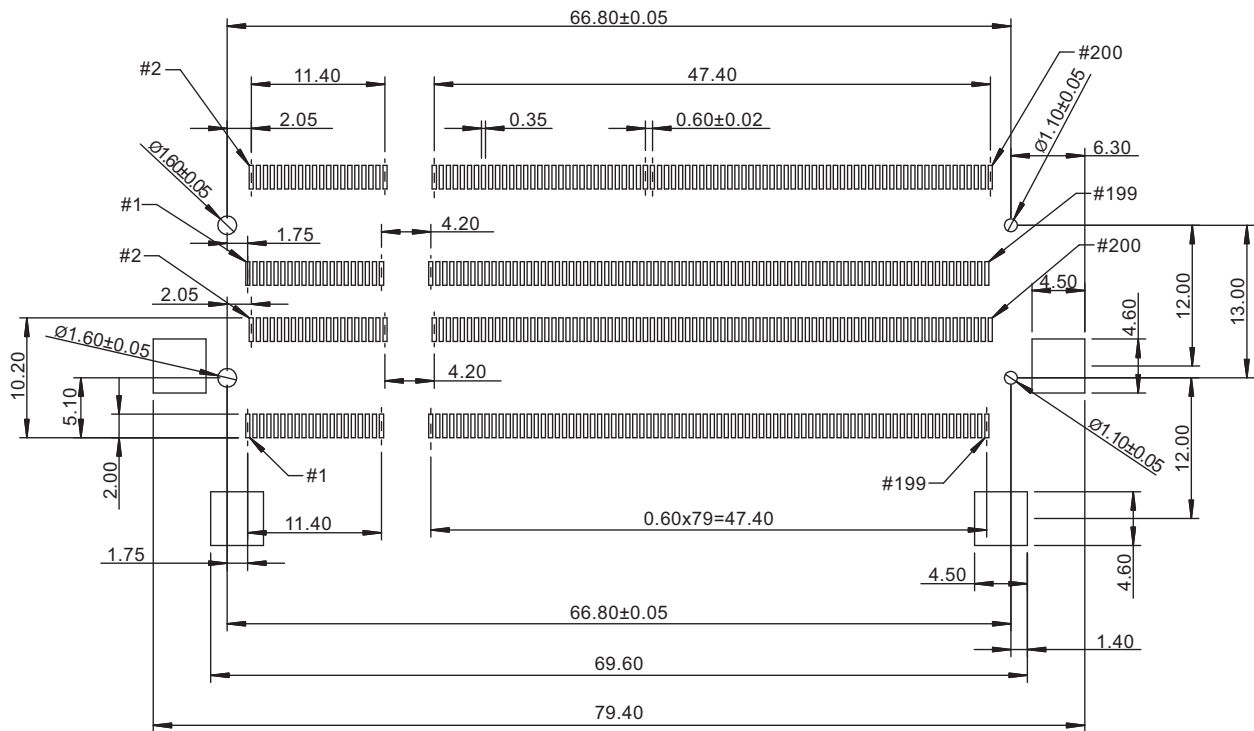
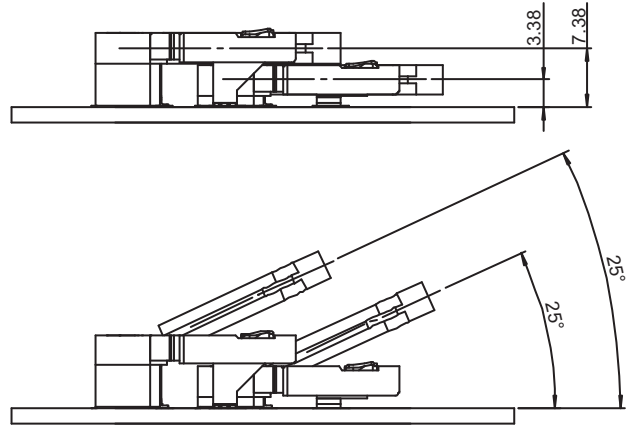
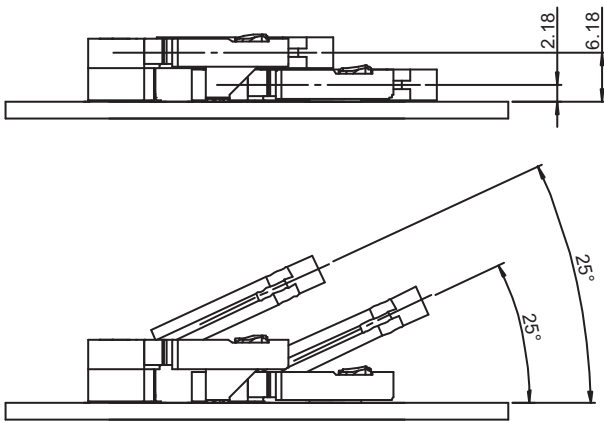


Mechanical dimensions

Unit: mm

4.0 & 8.0 Overlay figure

5.2 & 9.2 Overlay figure



Recommended P.C.B. layout component side

Tolerances		
Linear	X.	± 0.30
	.X	± 0.20
	.XX	± 0.10
	.XXX	± 0.05

